

FDC6331L

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	racteristics				•	•
BVIN	Vin Breakdown Voltage	$V_{ON/OFF} = 0 V, I_D = -250 \mu A$	8			V
Load	Zero Gate Voltage Drain Current	$V_{IN} = 6.4 \text{ V}, V_{ON/OFF} = 0 \text{ V}$			-1	μΑ
I _{FL}	Leakage Current, Forward	V _{ON/OFF} = 0 V, V _{IN} = 8 V			-100	nA
I _{RL}	Leakage Current, Reverse	V _{ON/OFF} = 0 V, V _{IN} = -8 V			100	nA
On Cha	racteristics (Note 2)					
VON/OFF (th)	Gate Threshold Voltage	$V_{IN} = V_{ON/OFF}$, $I_D = -250 \ \mu A$	0.4	0.9	1.5	V
R _{DS(on)}	Static Drain–Source On–Resistance (Q2)	$\begin{array}{c c} V_{GS} = -4.5 \text{ V}, & I_D = -2.8 \text{ A} \\ V_{GS} = -2.5 \text{ V}, & I_D = -2.5 \text{ A} \\ V_{GS} = -1.8 \text{ V}, & I_D = -2.0 \text{ A} \end{array}$		34 45 64	55 70 100	mΩ
R _{DS(on)}	Static Drain–Source On–Resistance (Q1)	$V_{GS} = 4.5 V, I_D = 0.4A$ $V_{GS} = 2.7 V, I_D = 0.2 A$		3.1 3.8	4 5	Ω

Drain-Source Diode Characteristics and Maximum Ratings

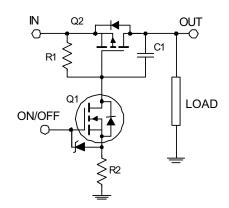
ls	Maximum Continuous Drain–Source Diode Forward Current			-0.6	A
V _{SD}	Drain–Source Diode Forward Voltage	$V_{ON/OFF} = 0 V, I_S = -0.6 A$ (Note 2)		-1.2	V

Note

Notes: 1. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0JA} is determined by the user's board design.

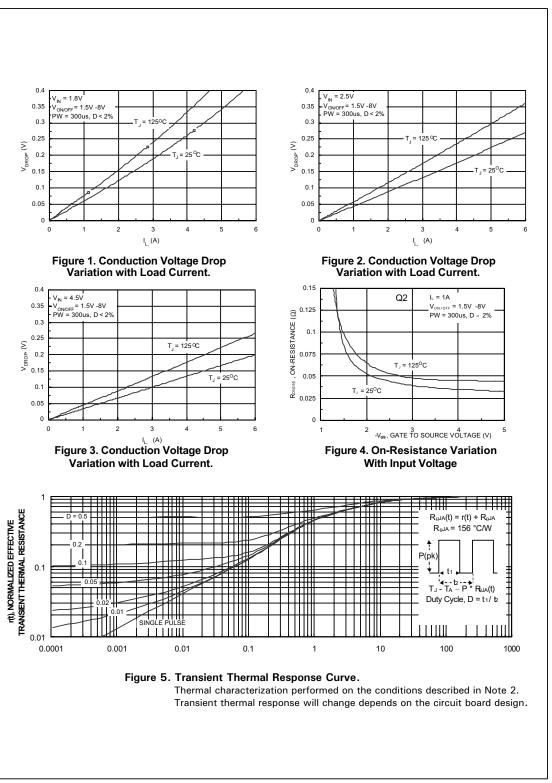
2. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%.

FDC6331L Load Switch Application Circuit



External Component Recommendation: For additional in-rush current control, R2 and C1 can be added. For more information, see application note AN1030.

FDC6331L Rev D



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